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Vishay Siliconix

N-Channel 30 V (D-S) MOSFET



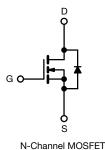
PRODUCT SUMMARY					
V _{DS} (V)	30				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.047				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.065				
Q _g typ. (nC)	3.0				
I _D (A)	4.0				
Configuration	Single				

FEATURES

- TrenchFET® power MOSFET
- 100 % R_g and UIS tested







ORDERING INFORMATION	
Package	SOT-23 (TO-236)
Lead (Pb)-free	Si2306BDS-T1-E3
Lead (Pb)-free and halogen-free	Si2306BDS-T1-GE3

DADAMETED		SYMBOL	LIMIT	UNIT
PARAMETER				UNIT
Drain-source voltage		V _{DS}	30	V
Gate-source voltage		V_{GS}	± 20	•
Continuous drain current (T _J = 150 °C) ^{a, b}	T _A = 25 °C		4.0 °	
	T _A = 70 °C		3.5 ^c	
	T _A = 25 °C	I _D	3.16 ^d	
	T _A = 70 °C		2.7 ^d	Α
Pulsed drain current		I _{DM}	20	
Continuous source-drain diode current a, b		,	1.04 °	
		I _S	0.62 ^d	
Maximum power dissipation ^{a, b}	T _A = 25 °C		1.25 °	
	T _A = 70 °C		0.8 °	\A/
	T _A = 25 °C	P _D	0.75 ^d	W
	T _A = 70 °C		0.48 ^d	
Operating junction and storage temperature ran	ge	T _J , T _{stq}	-55 to +150	°C

Notes

- a. Surface mounted on 1" x 1" FR4 board, $t \le 5$ s
- b. Pulse width limited by maximum junction temperature
- c. t = 5 s
- d. Steady state

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THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^a	t ≤ 5 s	R_{thJA}	60	100	
Maximum junction-to-ambient ~	Steady state		130	166	°C/W
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	60	75	

Note

a. Surface mounted on 1" x 1" FR4 board

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•	<u>'</u>	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0	-	3.0	V
Gate-body leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zava gata valtaga duain avuvant		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	0.5	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 4.5 \text{ V}, V_{GS} = 10 \text{ V}$	6	-	-	Α
Drain-source on-state resistance a	Б	V _{GS} = 10 V, I _D = 3.5 A	-	0.038	0.047	-
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 2.8 \text{ A}$	-	0.052	0.065	Ω
Forward transconductance a	9 _{fs}	$V_{DS} = 4.5 \text{ V}, I_D = 2.5 \text{ A}$	-	7.0	-	S
Diode forward voltage	V _{SD}	V _{GS} = 0 V, I _S = 1.25 A	-	0.8	1.2	V
Dynamic						
Gate charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 2.5 \text{ A}$	-	3.0	4.5	
Total gate charge	Q _{gt}		-	6	9	nC
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2.5 \text{ A}$	-	1.6	-	i iiC
Gate-drain charge	Q _{gd}		-	0.6	-	1
Gate resistance	R_g	f = 1 MHz	2.0	5.0	7.5	Ω
Input capacitance	C _{iss}		-	305	-	
Output capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	65	-	pF
Reverse transfer capacitance	C _{rss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ - 65 - 29 -		-	7	
Switching						
Turn-on delay time	t _{d(on)}		-	7	11	
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_L = 15 \Omega, \text{ I}_D \cong 1 \text{ A},$	-	12	18	
Turn-off delay time	t _{d(off)}	$V_{\text{DEN}} = 13 \text{ V}, \text{ NL} = 13 \Omega, \text{ ID} = 1 \text{ A},$ $V_{\text{GEN}} = 0 \text{ V}, \text{ Rg} = 6 \Omega$ - 14		14	25	ns
Fall time	t _f		-	6	10	1
Reverse recovery time	t _{rr}	1 4 05 4 4:/44 400 4/ -	-	14	21	1
Body diode reverse recovery charge	Q _{rr}	I _F = 1.25 A, di/dt = 100 A/μs	-	6	10	nC

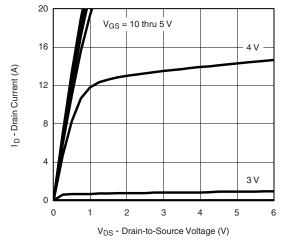
Notes

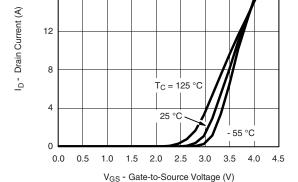
a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



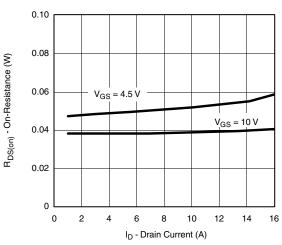


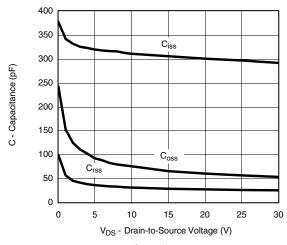
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16

Output Characteristics

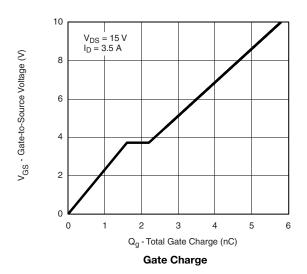


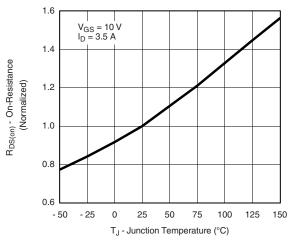




On-Resistance vs. Drain Current

Capacitance

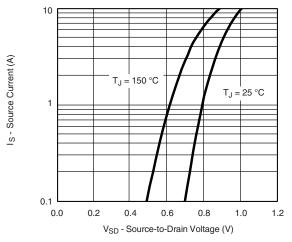




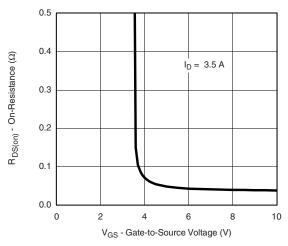
On-Resistance vs. Junction Temperature



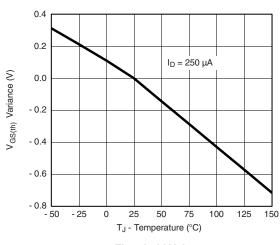
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



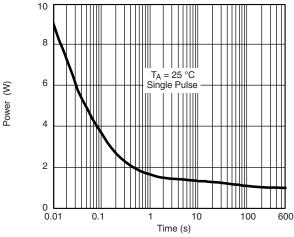
Source-Drain Diode Forward Voltage



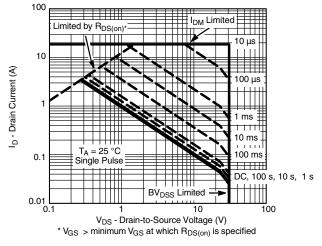
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



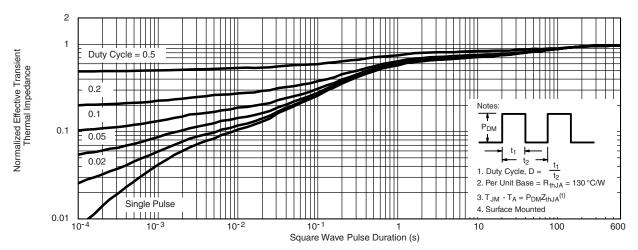
Single Pulse Power



Safe Operating Area



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

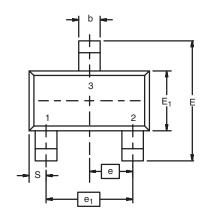


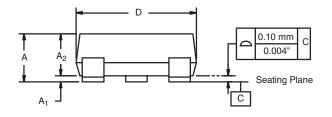
Normalized Thermal Transient Impedance, Junction-to-Ambient

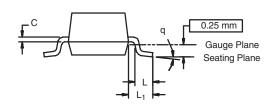
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SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025	i Ref	
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	

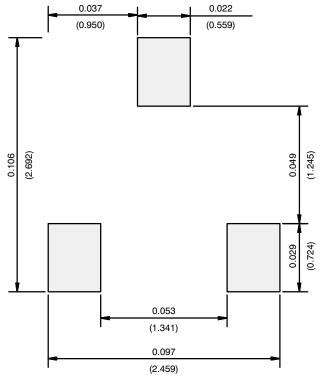
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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



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